

Reliability Assurance of CubeSat Payloads using GSN, Bayesian Nets and Radiation- Induced Fault Propagation Models

Arthur Witulski, P.I., Gabor Karsai, Co-P.I., Nag Mahadevan, Rebekah Austin, Brian Sierawski, Ron Schrimpf, Robert Reed

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Small Satellite TIM 10/11/17

Integrated System Design for Radiation Environments*



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Requirements

*This slide and many of the following from: R. Austin, "Reliability Assurance of CubeSat Payloads using Bayesian Nets and Radiation-Induced Fault Propagation Models," Single Event Symposium 2017

Design

Reliability

Integrated System Design for Radiation Environments



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SEAM paradigm:
System Engineering
and Modeling

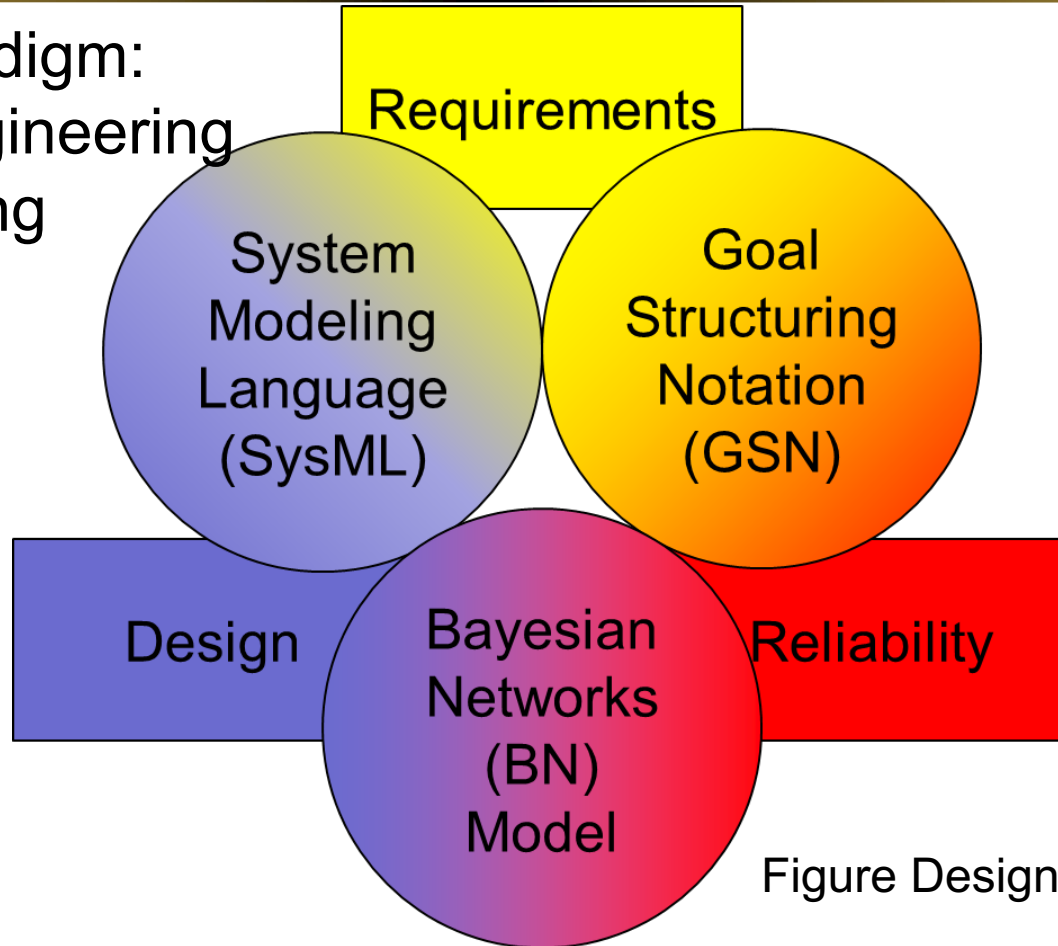


Figure Design: Rebekah Austin

Motivation for Alternate Reliability Approach



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- Shift from document-centric to model-centric repository of design information (SysML)
 - Shift from prescriptive reliability paradigm to objectives-based paradigm for reliability
 - NASA-STD-8729.1A Reliability and Maintainability Std.
 - Goal Structuring Notation (GSN)
 - Increased use of COTS parts on spacecraft
 - Relatively little info on physics of parts available from manufacturers
 - High variability in radiation response of COTS parts
 - Well-suited to probabilistic modeling (Bayesian nets)
 - Rapid acceptance and deployment of small spacecraft
 - Short schedule, limited budget and resources
 - Extensive radiation testing and rad-hard parts not feasible
-

Chronological Overview of Research Effort



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- Year 1 (FY 2016): Use of GSN to create a safety case for the impact of single events on a Cube Sat experiment board
 - Sponsored by John Evans (OSMA/HQ) and Ken LaBel (NEPP)
 - Year 2 (FY 2017): Development of SysML/GSN/BN model on Cube Sat Experiment board
 - Sponsored by John Evans (OSMA/HQ) and Ken LaBel (NEPP)
 - Development and launch of public website deployed on AWS
 - Year 2 (FY2017): TID and Reliability Modeling of Sphinx C&DH board
 - Sponsored by Harald Schone and Phillipe Adell (OSMS) at JPL
 - First task: deterministic modeling of TID impact on system parameters
 - Second task: application of SEAM modeling to Sphinx board
-

Chronological Overview –Proposed Work



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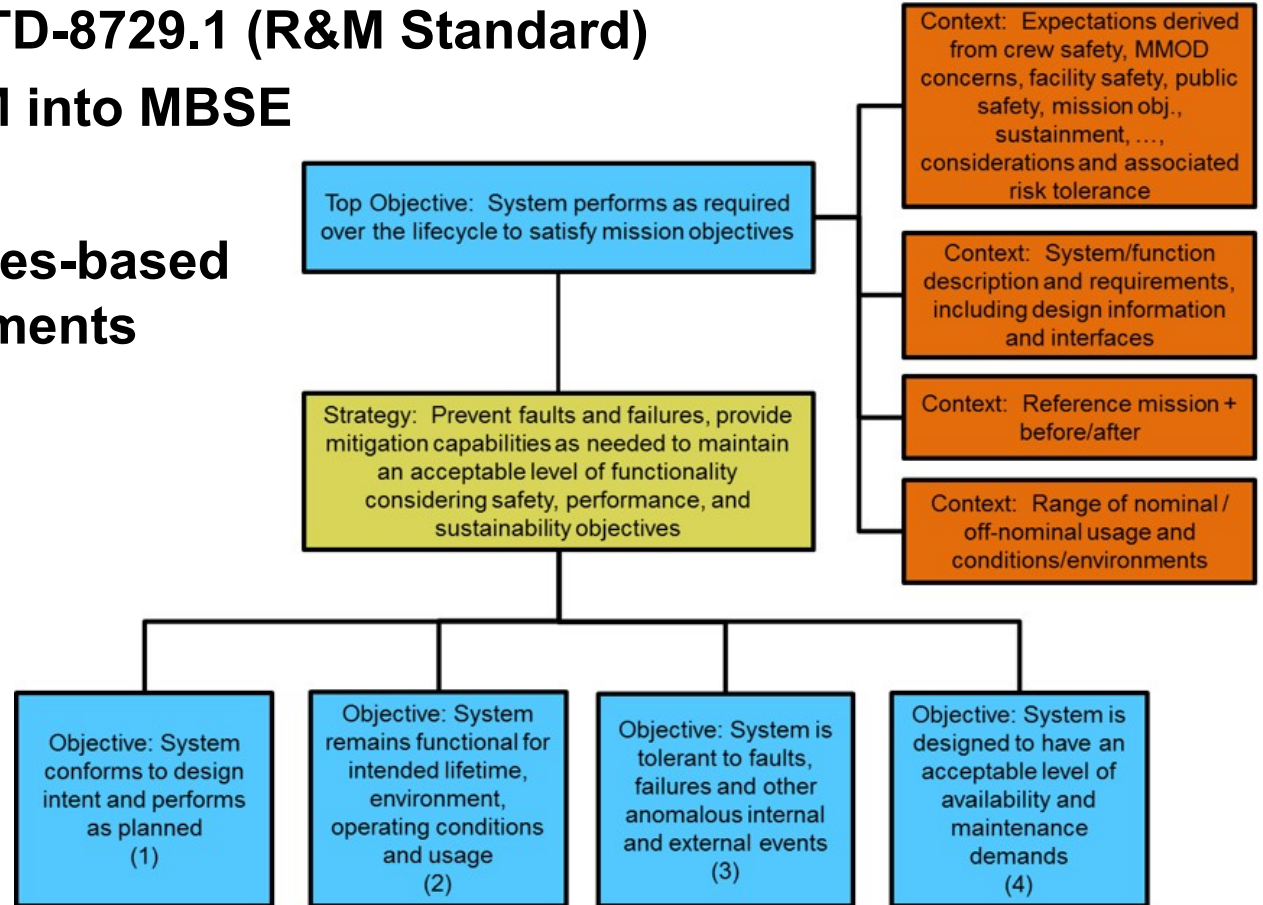
- Year 3 (FY 2018): Reliability of Cube Sat Board
 - Improve SysML import compatibility (e.g. MagicDraw),
 - move into automatic creation of Bayesian nets
 - Integrate with other reliability approaches
 - Sponsored by Ken LaBel (NEPP) and John Evans (OSMA/HQ)
 - Year 3 (FY2018): TID and Reliability Modeling of Sphinx C&DH board
 - TID modeling task: Work towards higher fidelity modeling, incorporation of software in simulation
 - SEAM tasks: create model library for Sphinx board components, interface SEAM modeling to IRIS system modeling (UCLA)
 - Sponsored by Harald Schone and Phillippe Adell (OSMS) at JPL
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Foundation: NASA Reliability & Maintainability (R&M) Hierarchy



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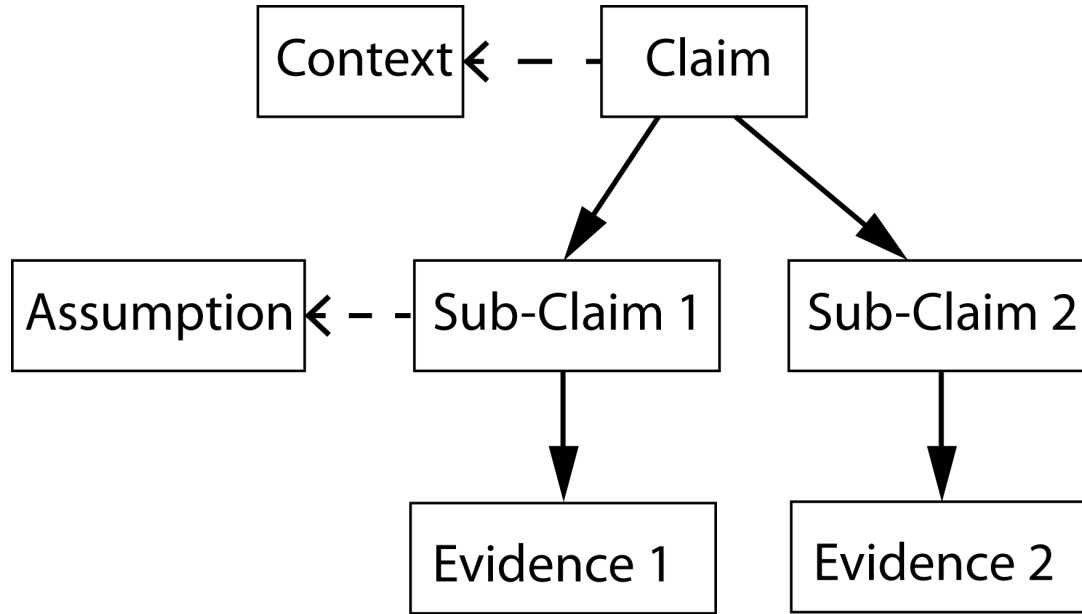
- **Basis of NASA-STD-8729.1 (R&M Standard)**
- **Incorporates R&M into MBSE**
- **Moves to objectives-based reliability requirements**



Graphical Assurance Cases



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Argument: “A connected series of claims intended to support an overall claim.” [1]

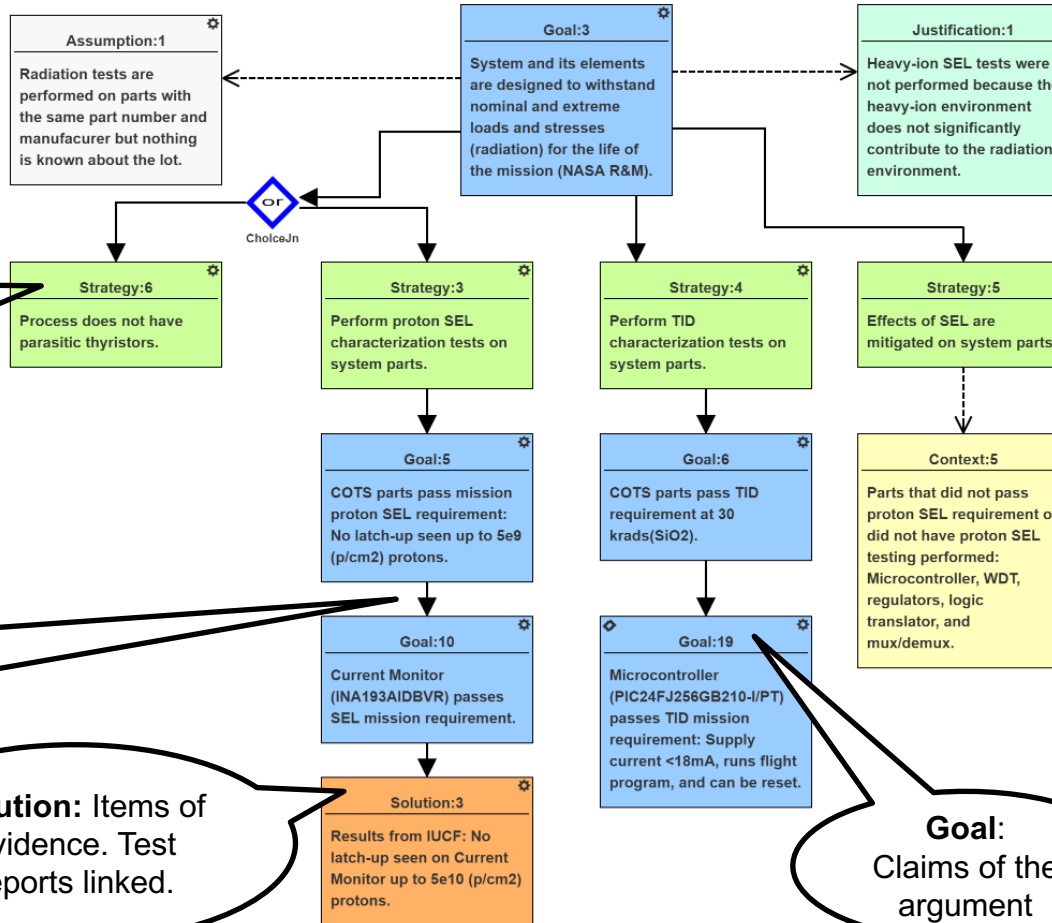
Assurance Case: “A reasoned and compelling argument, supported by a body of evidence, that a system, service or organization will operate as intended for a defined application in a defined environment.” [1]

[1] GSN Community Standard Version 1 2011

Goal Structuring Notation (GSN): Visual Representation of an Argument



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Strategy:
Reasoning step, nature of argument

Supported by:
Inferential or evidential relationships

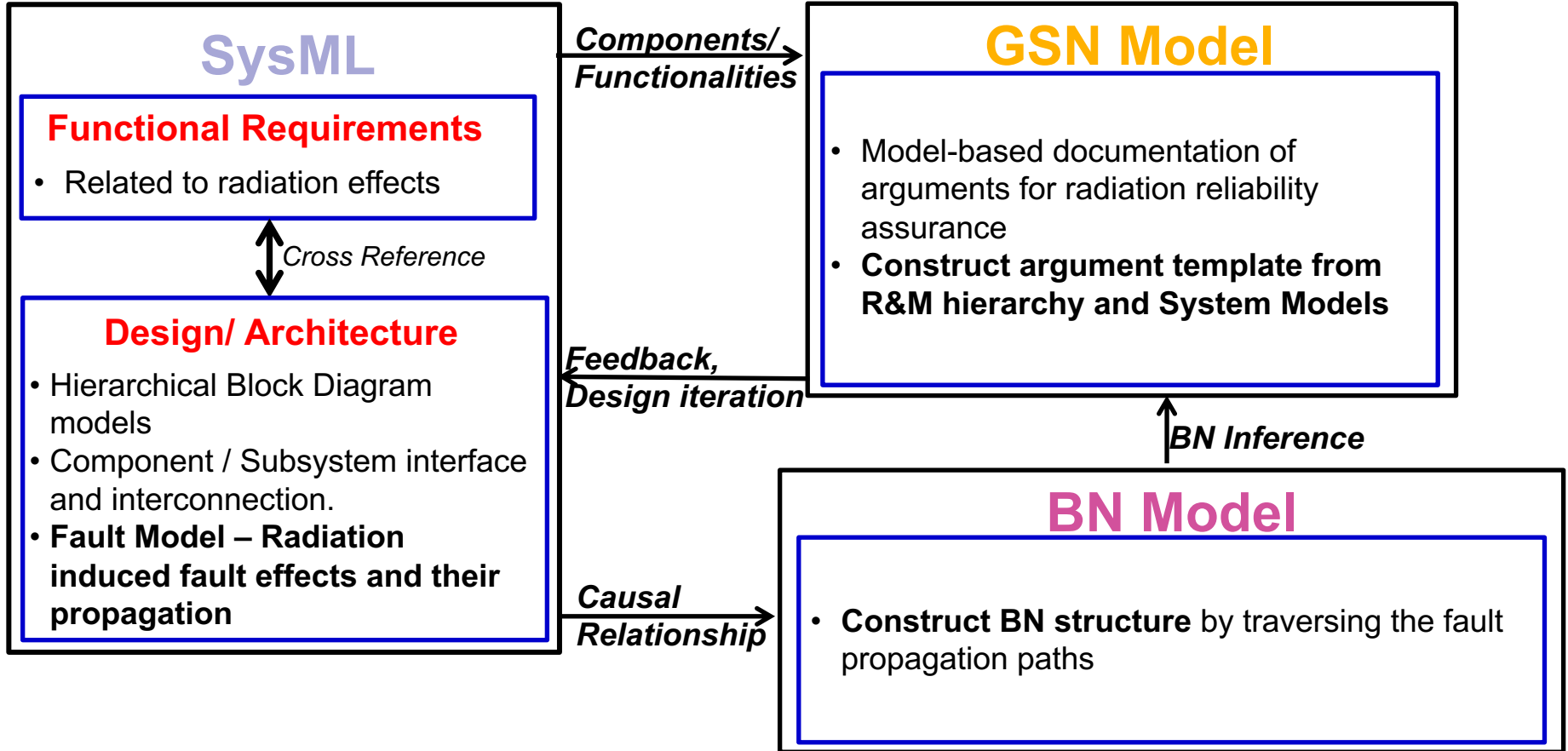
Solution: Items of evidence. Test reports linked.

Goal:
Claims of the argument

Model Integration of SysML, GSN, and BN*



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Overview of Modeling Languages Used



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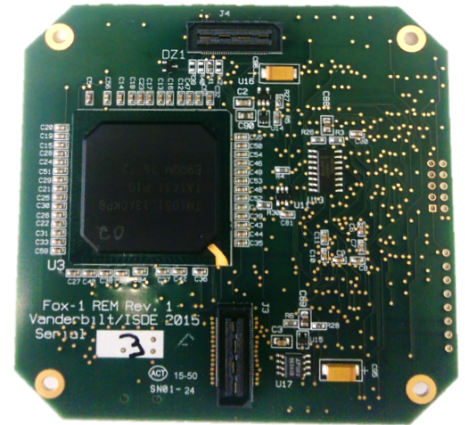
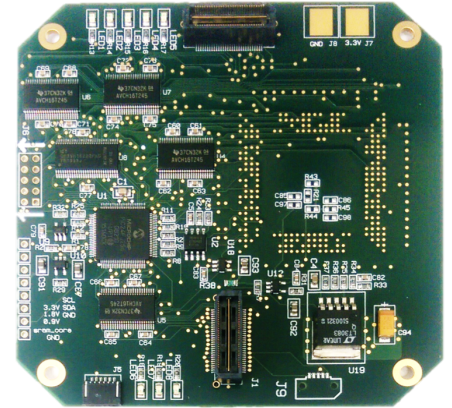
SysML	GSN	BN Network
<ul style="list-style-type: none"> • Specification of systems through standard notation • Added fault propagation paths 	<ul style="list-style-type: none"> • Visual representation of argument • Goals, Strategies, and Solutions 	<ul style="list-style-type: none"> • Nodes describe probabilities of states • Calculate conditional probabilities from observations

Radiation Reliability Assessment of CubeSat SRAM Experiment Board



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- **Assessment completed on REM**
 - 28nm SRAM SEU experiment
- **Reasons for integrated modeling**
 1. Use commercial off-the-shelf (COTS) parts
 2. System mitigation of SEL
 3. System mitigation of SEFI on microcontroller

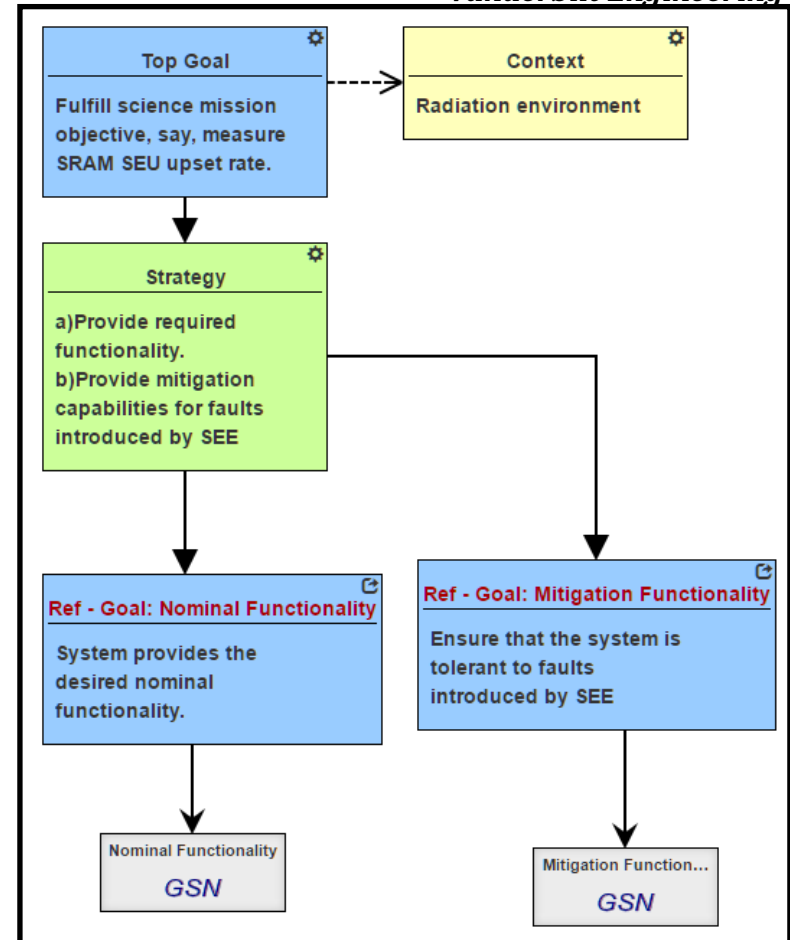
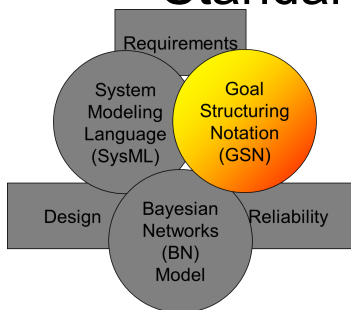




Top Level GSN Model of REM Experiment Board

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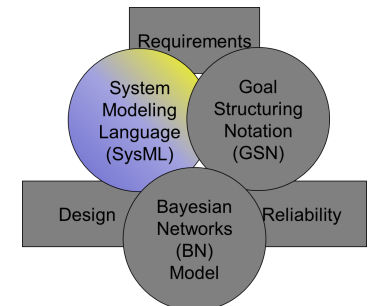
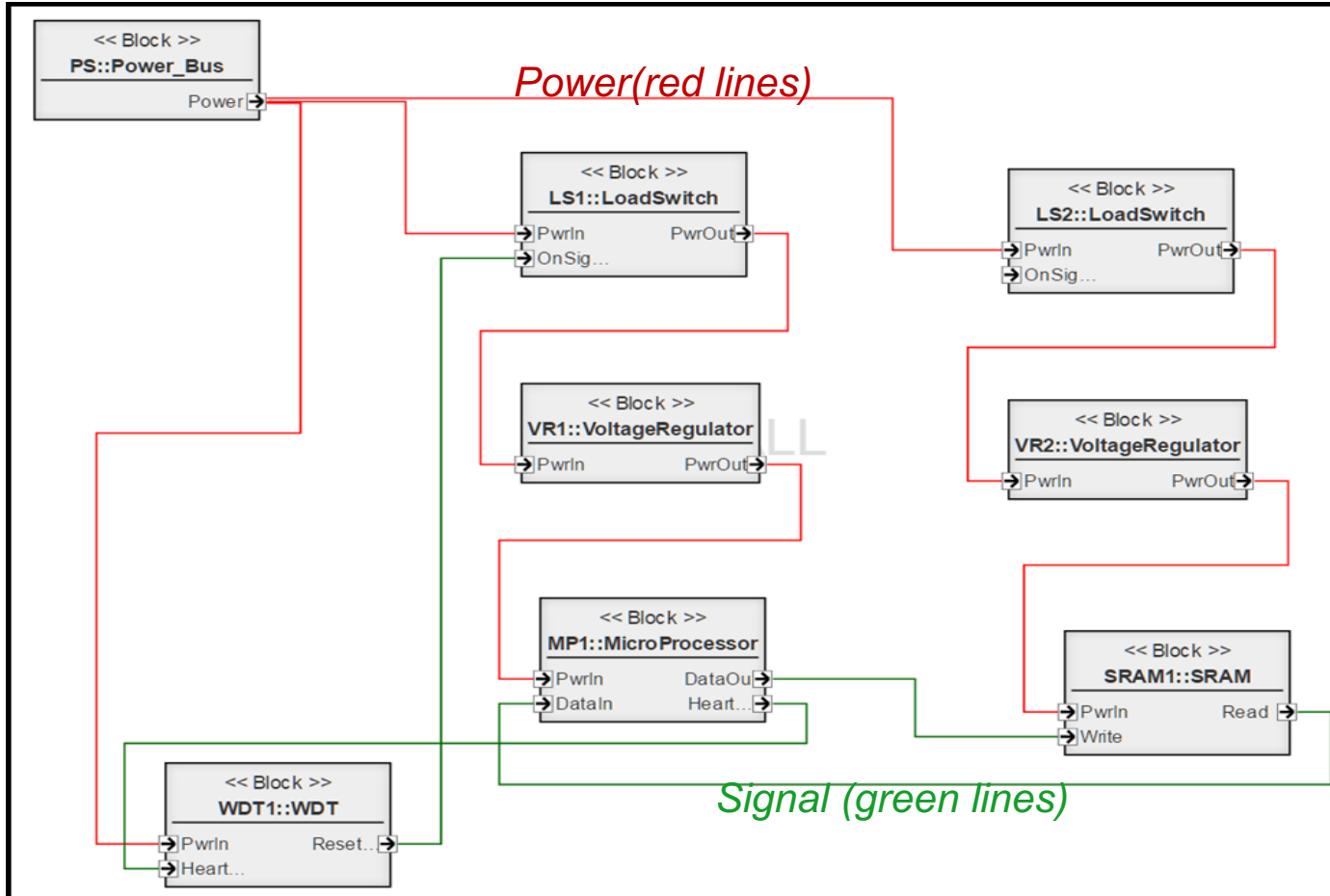
- **Top level goal: Complete science mission objective**
- **Strategies: Provided functionality and mitigate radiation environment**
- **Goals: Validation of “Nominal” and “Mitigation” functionalities**
 - Focused on radiation-induced faults
 - Adapted from NASA R & M Standard



SysML Block Diagram of REM Experiment Board



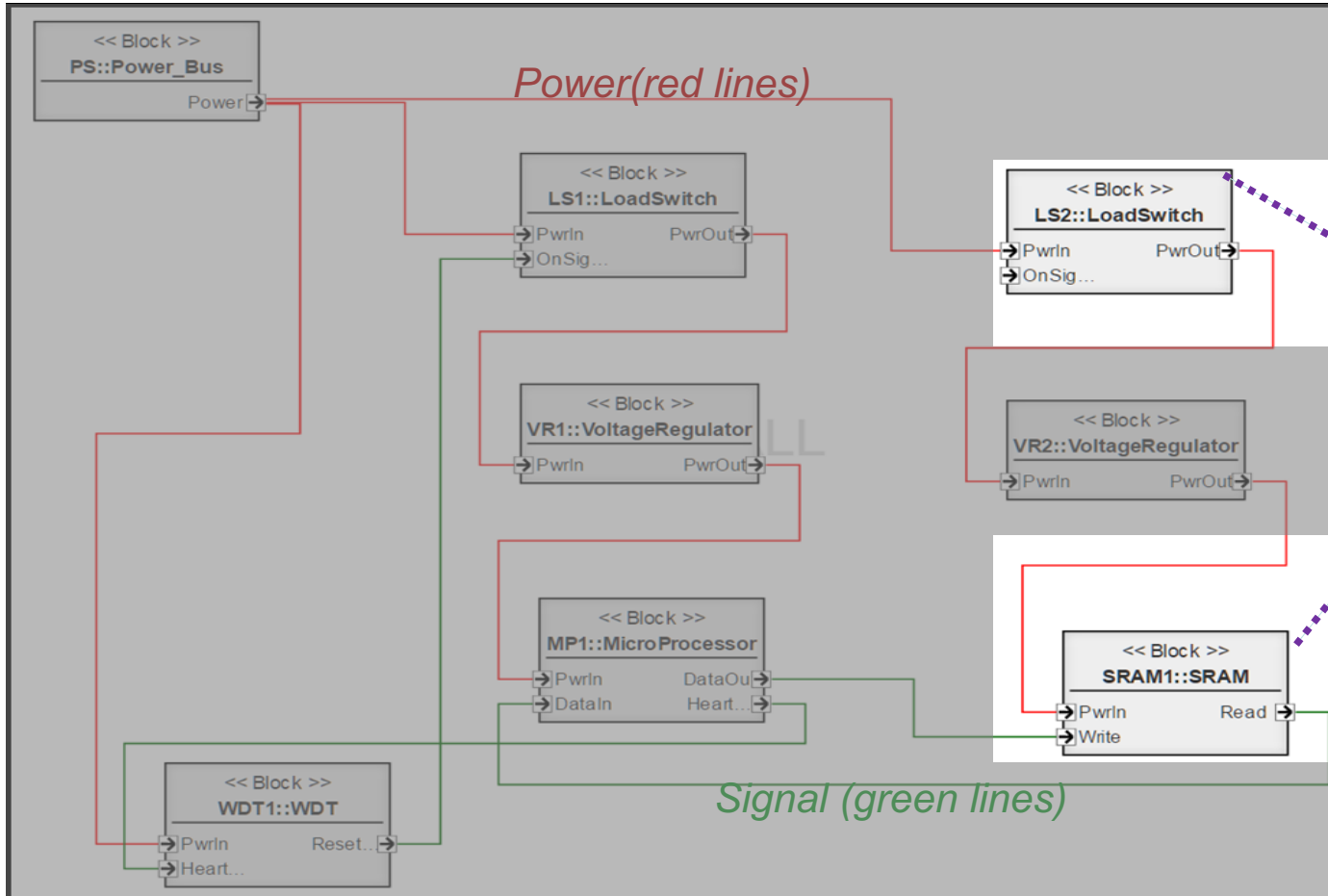
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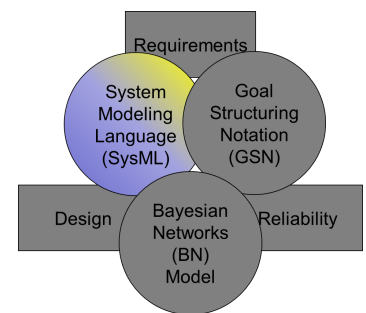
SysML Block Diagram of REM Experiment Board



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Focus on Load Switch, SRAM subsystem



SysML Internal Block Diagram with Fault Propagation Paths

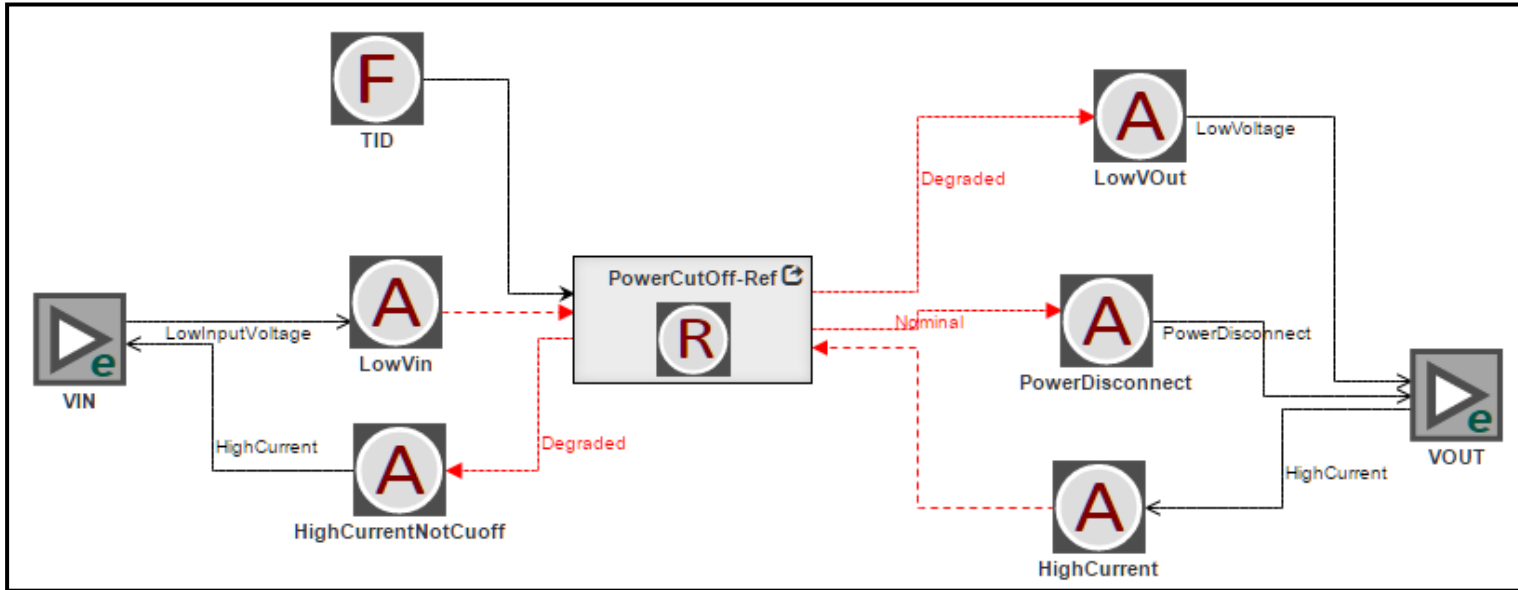
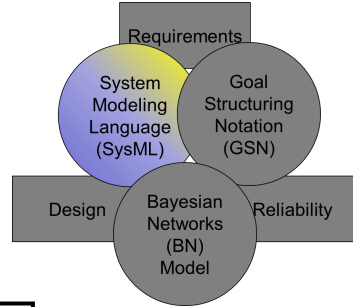


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- **Load Switch**

- Faults (F)
- Anomalies (A)
- Responses (R)

- Nominal response
- Degraded response
- Ports

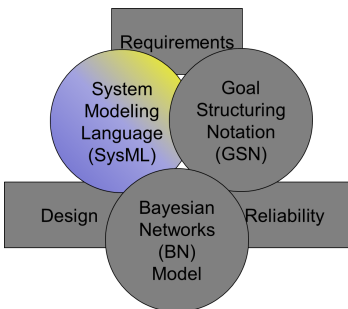
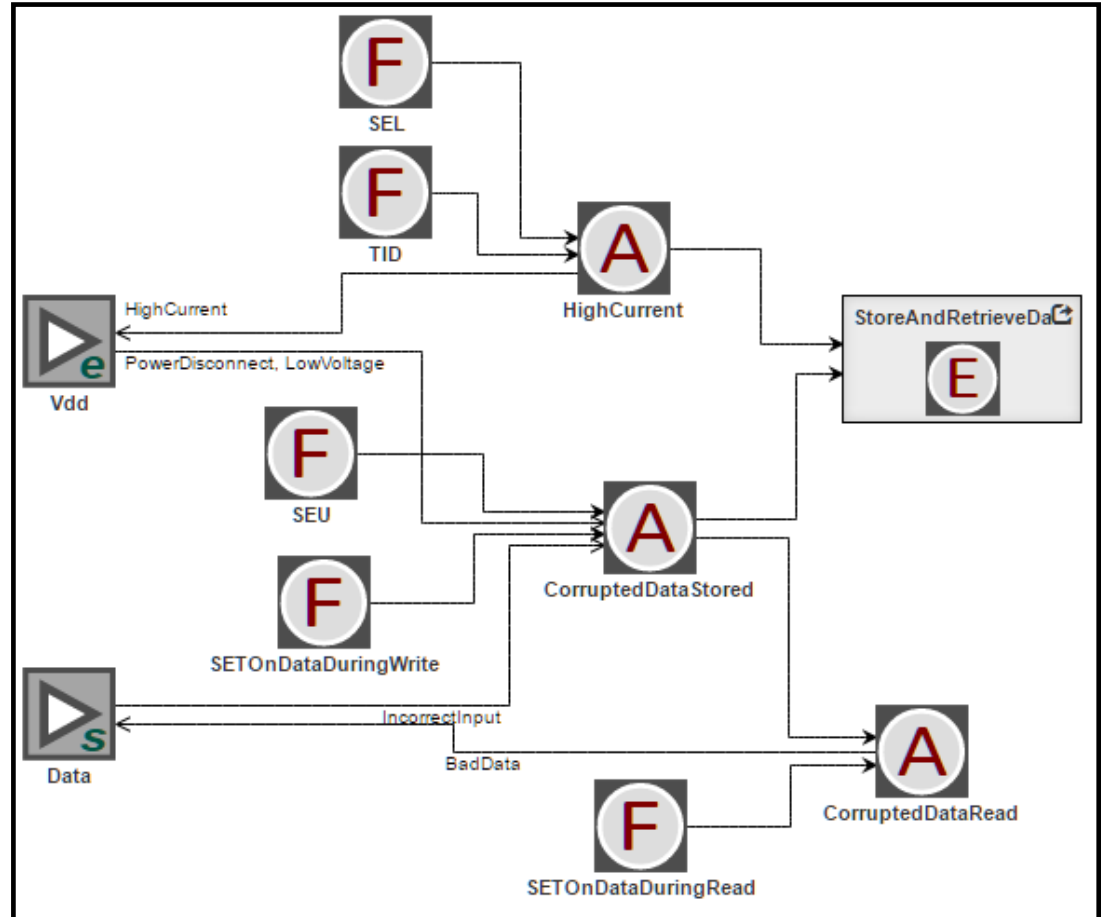


SysML Internal Block Diagram with Fault Propagation Paths



- **SRAM**

- Effects (E)
- Faults on different inputs

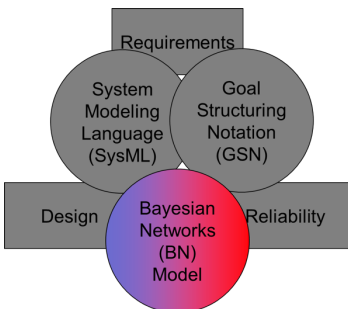
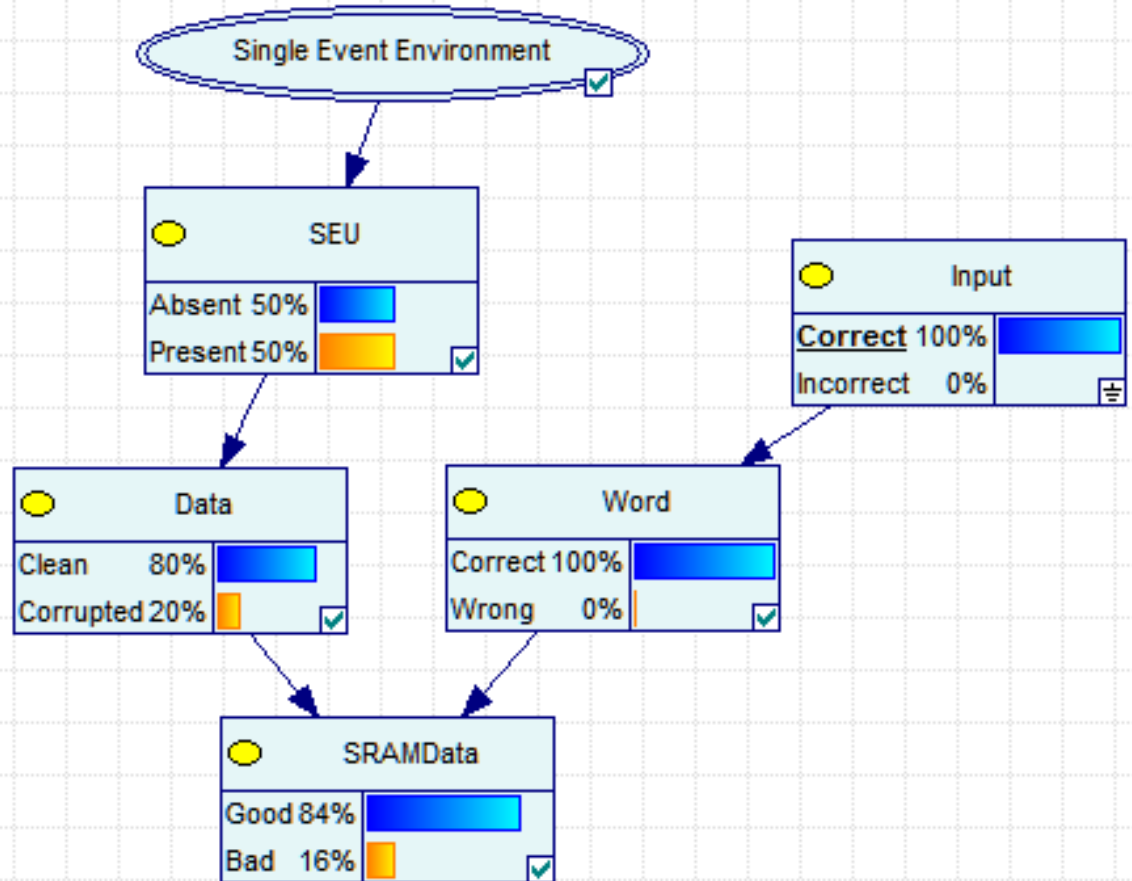


Pruned Bayesian Network Model of the REM Experiment Board



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- SEE environment set to LEO or SAA
- Input is data from microcontroller
 - Assumed correct
- Show sensitivity of SRAM data to SEE environment

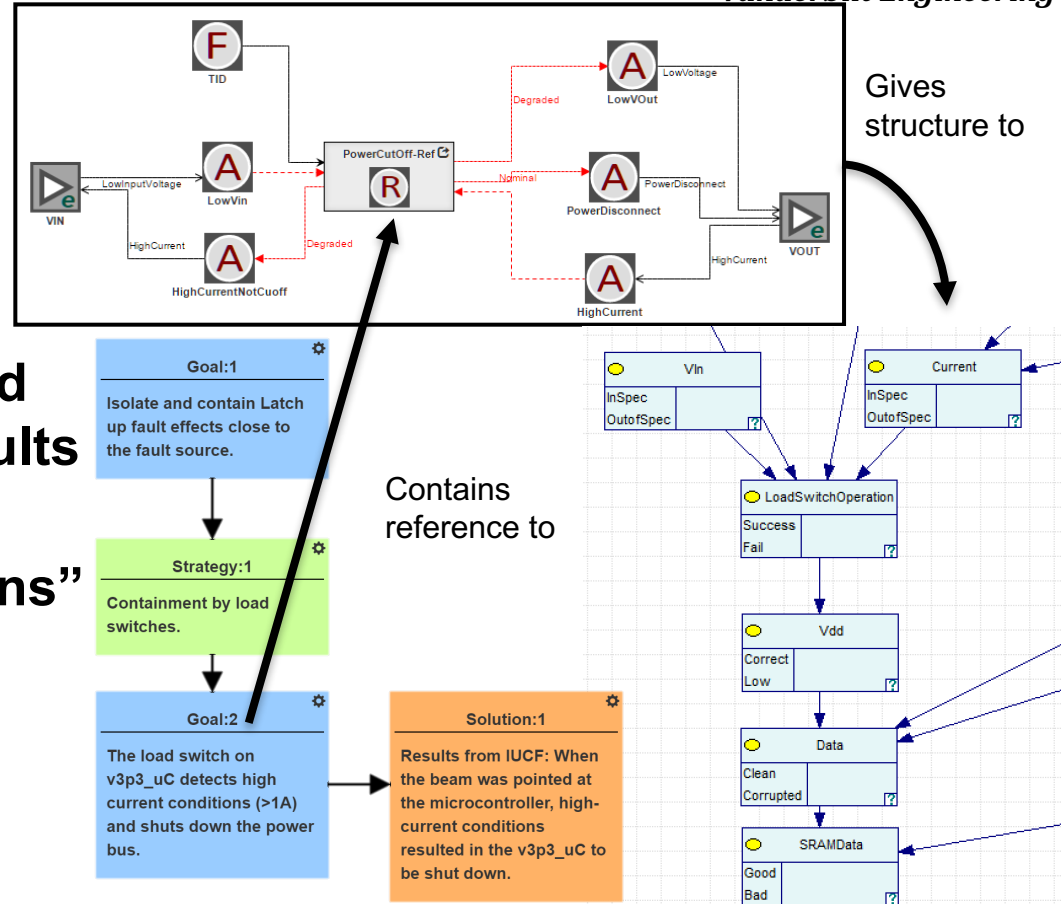


Summary



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- Developed integrated process for model-based assurance case for radiation reliability
- Constructed example SysML models augmented with radiation-induced faults and propagation
- BN inference “observations” used to assess impact of various faults on SRAM performance

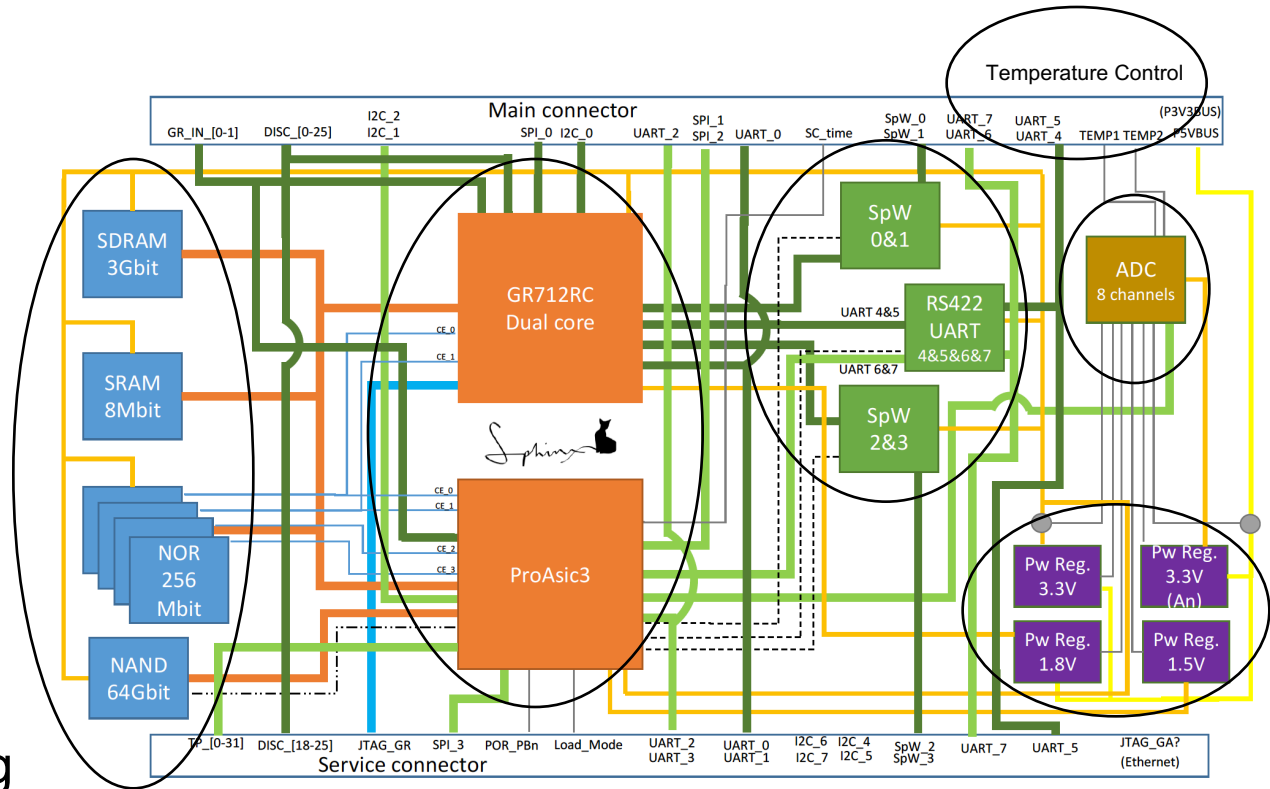


Modeling JPL Sphinx C&DH Board: Issues of Scale



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- Sphinx much more complex than Cube Sat board
- Hierarchy for managing complexity
- Schemes for categorizing sub-systems
- Subsystems based on functionality
- Components belong to more than one subsystem



Functional vs Schematic Organization Strategy



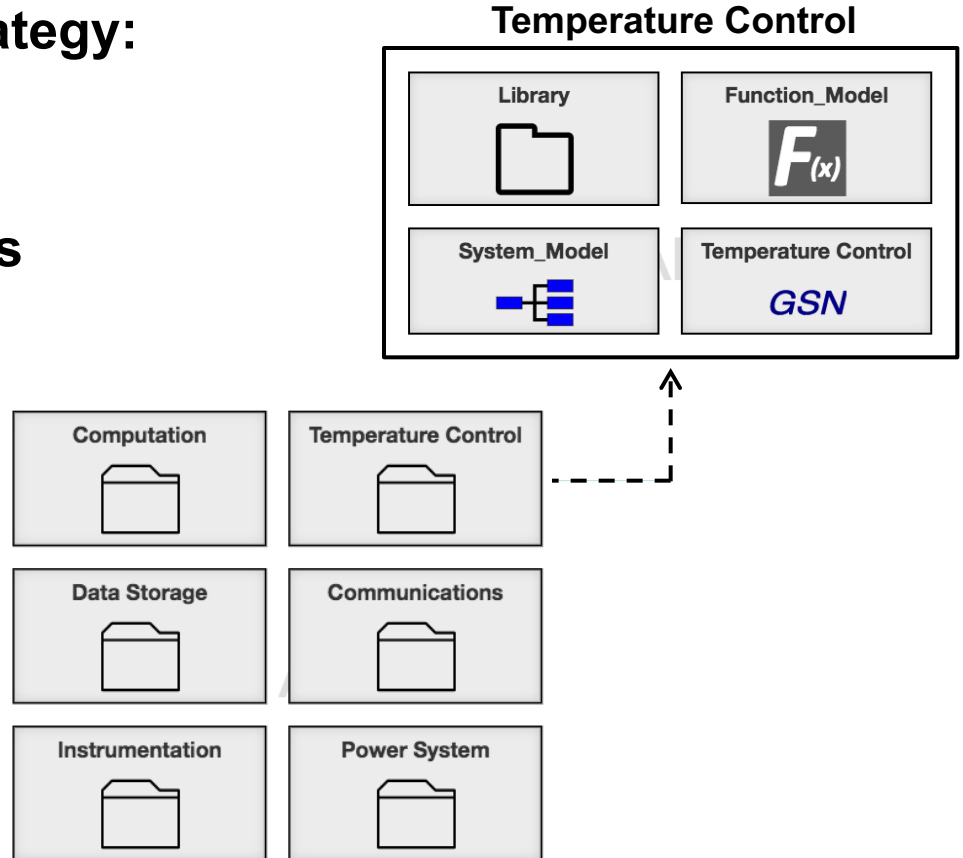
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Advantages of Functional Strategy:

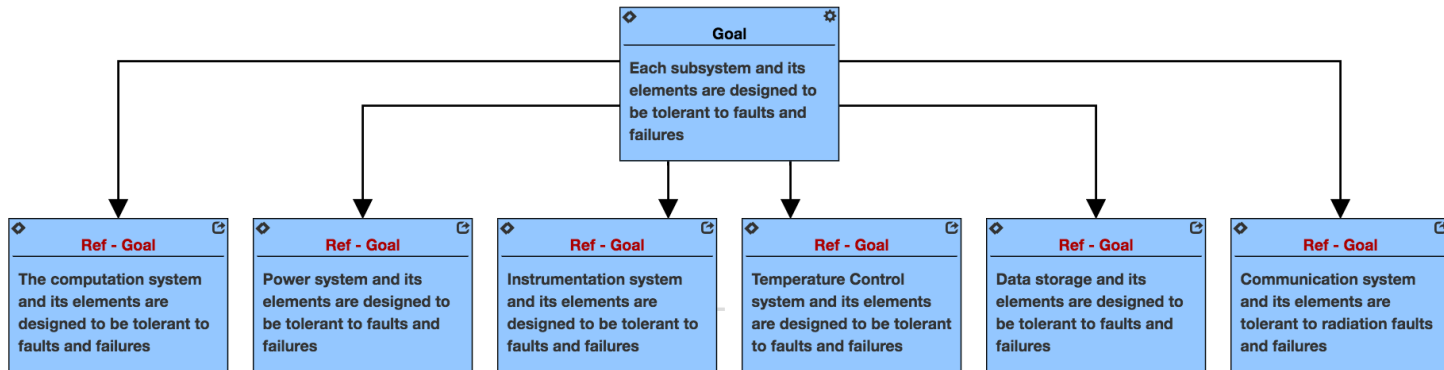
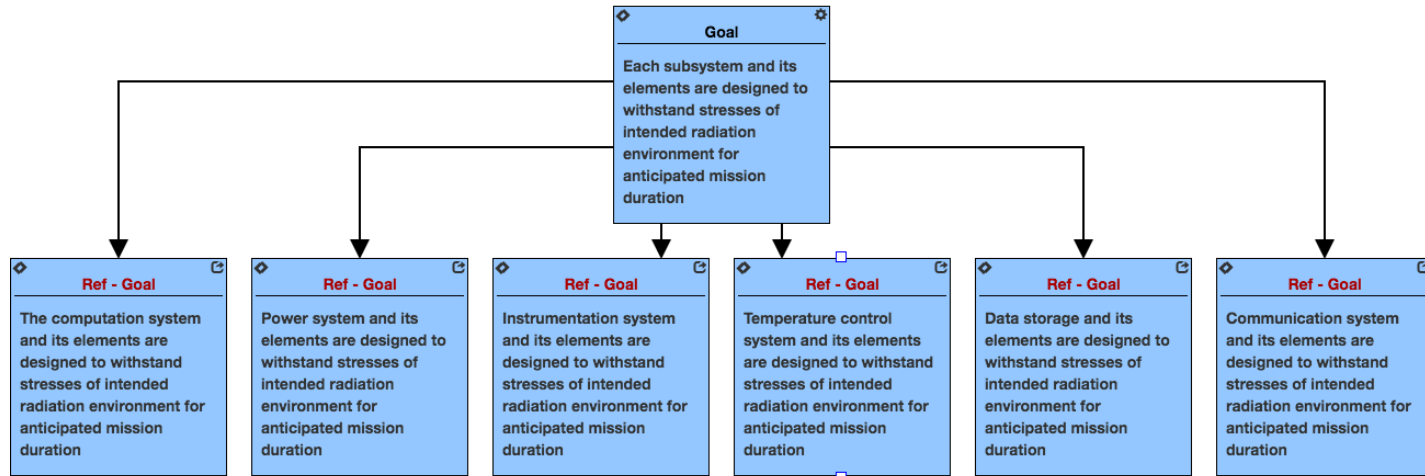
- Specifies purpose of components
- Simplifies functional models
- Parallels thinking of GSN arguments
- Abstraction level same as deterministic simulation

Disadvantages:

- Uses same components in multiple subsystems



GSN Radiation Parts Characterizations

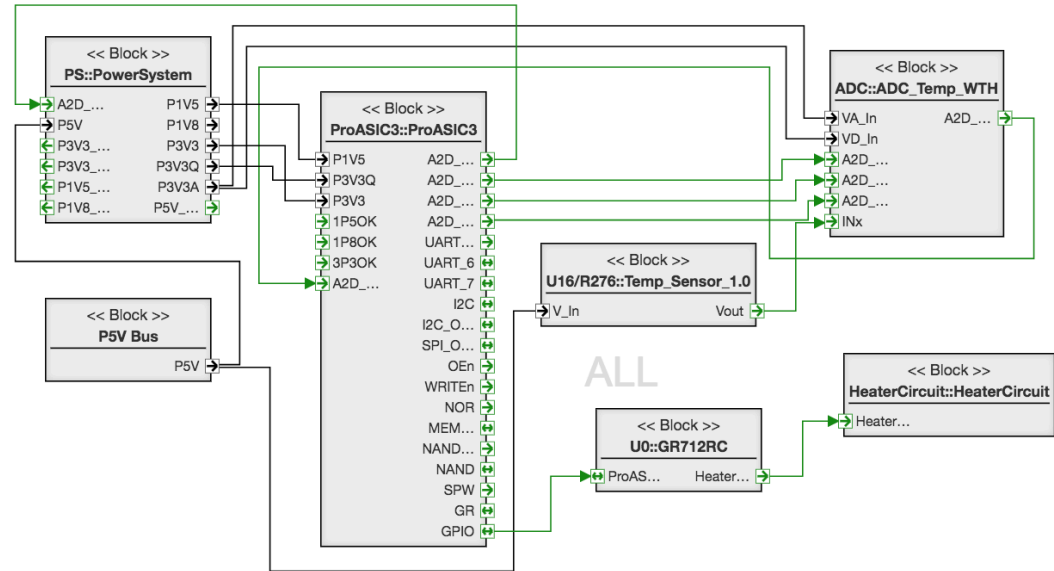


Deriving the Bayesian Net from SysML Models for the Temperature Loop Subsystem



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- Block Diagram view includes all components directly involved in system functionality
- Links connection paths directly involved in system functionality
- Visualizes fault and failure propagation paths

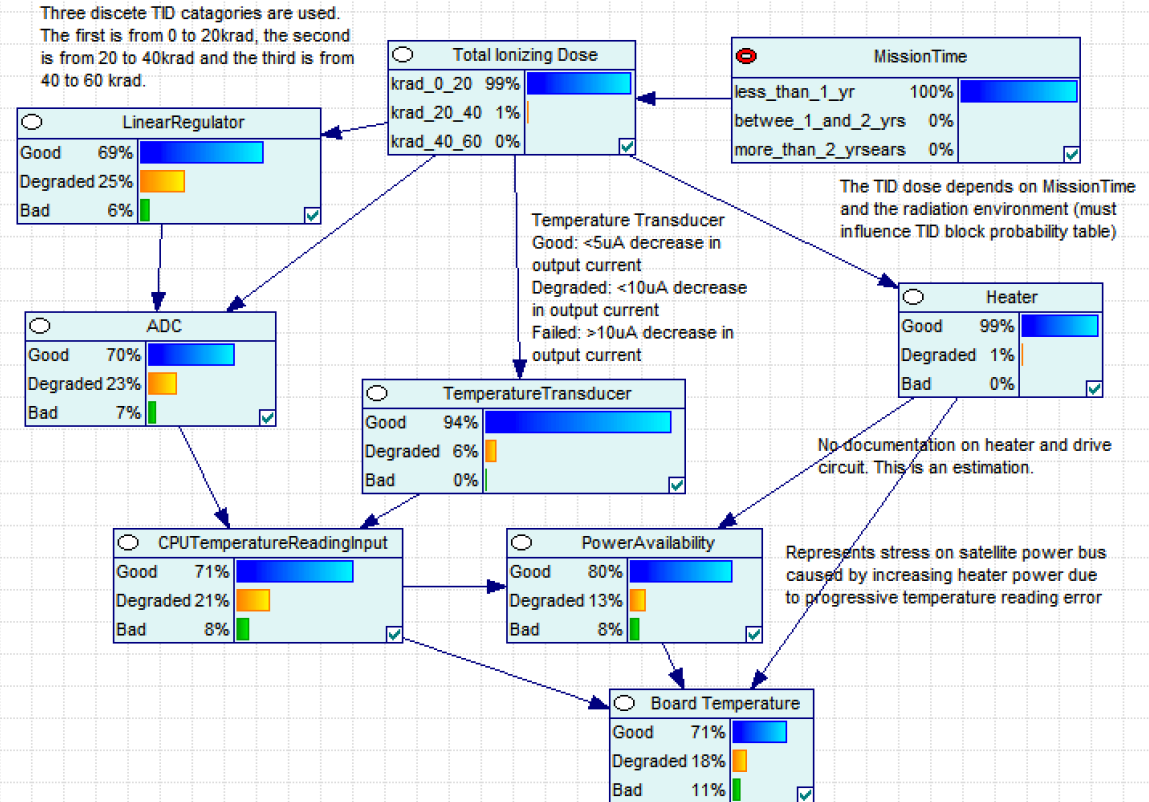


Temperature Control Bayesian Net



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- BN only considers TID (no SELs or external faults)
- MissionTime branch sets TID
- System output is board temperature
- PowerAvailability node represents stress on satellite power bus due to increased heater usage
- Annotations add details and assumptions





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Jet Propulsion Laboratory
California Institute of Technology

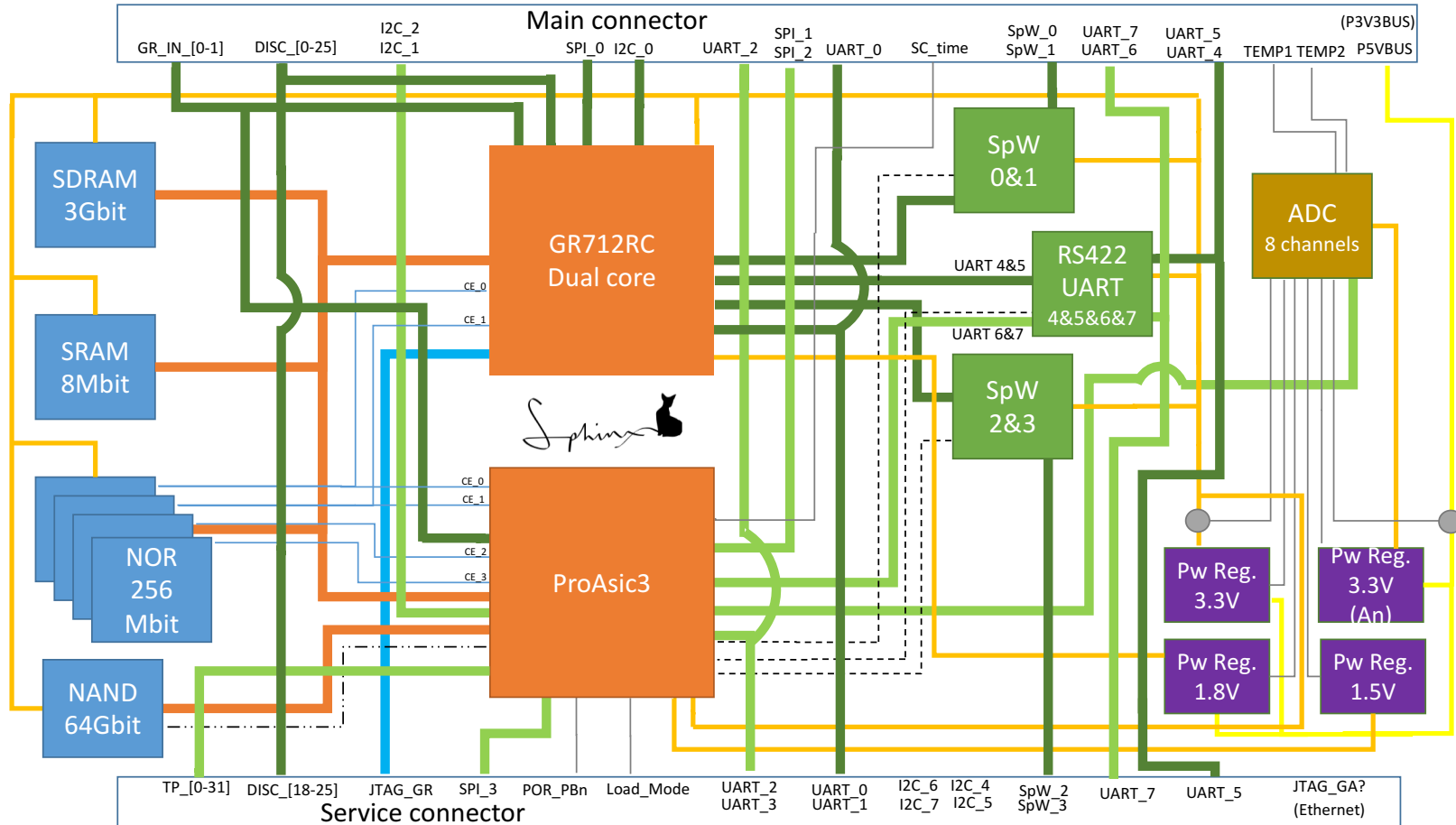
Overview of TID and Reliability Modeling of the JPL Sphinx C&DH Board

- Arthur Witulski, P.I., Gabor Karsai, Co-P.I., Nag Mahadevan, Jeff Kauppila,
 - Ronald Schrimpf, Robert Reed
-

JPL Sphinx C&DH Block Diagram



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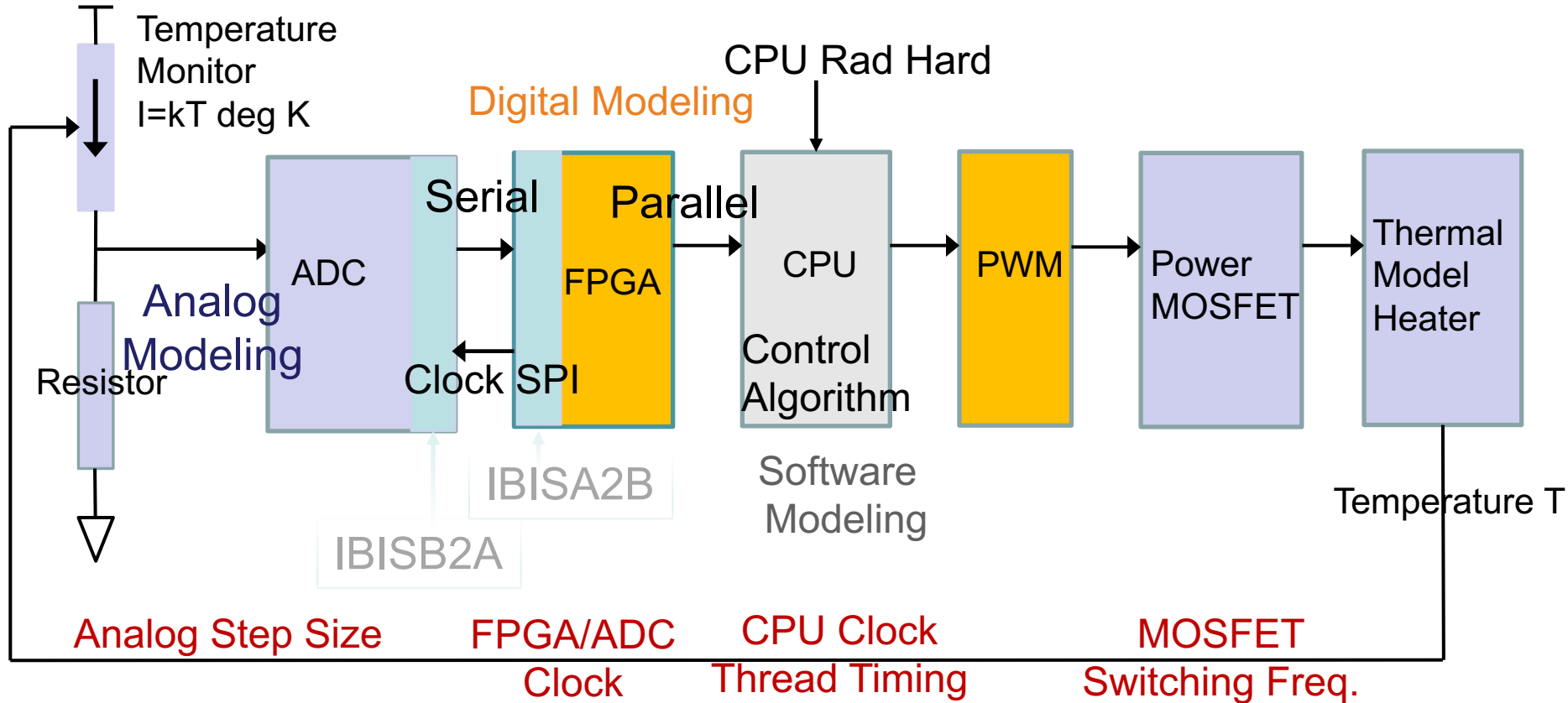


- **Problem:** How to estimate impact of transistor-level degradation on system-level performance?
 - Need fast modelling turn-around time so process can be iterative
 - Must be able to accommodate many signal and part types
 - Analog-SPICE-like continuous waveforms
 - Pure digital (one-zero level)
 - Digital in the electrical domain
 - Behavioral: VHDL and Verilog AMS
 - Software: Control algorithms, etc.
 - Must be tolerant of incomplete knowledge of part performance and radiation behavior
 - Need fast run time so Monte Carlo Bayesian approach is possible
-

Demonstration: Temperature regulation loop model with TID Degradation



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Radiation modeling embedded in parameter variation

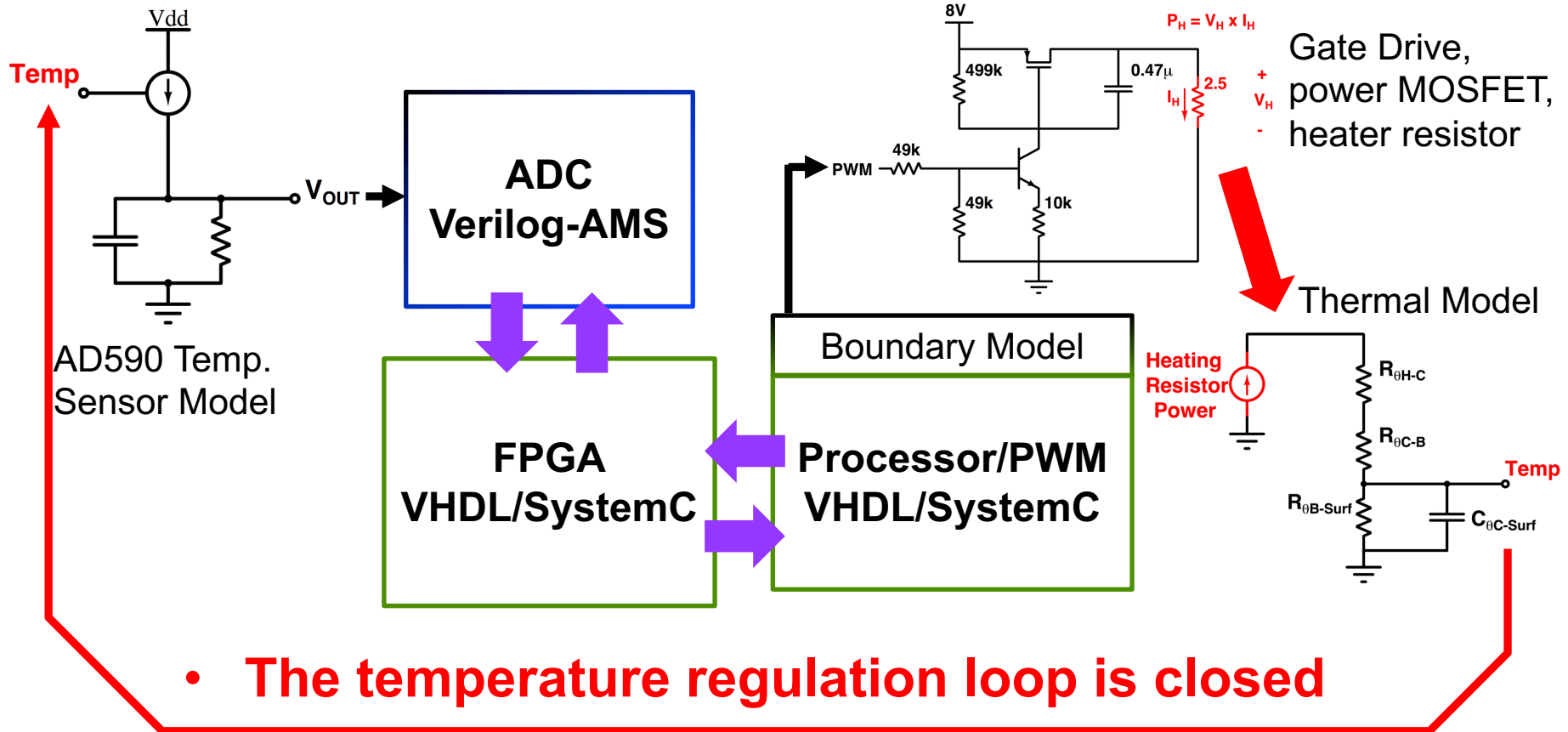


- The Questa ADMS simulation package from Mentor Graphics is the simulation engine within the Expedition PCB design flow
 - Capable of co-simulating SPICE, Behavioral (Verilog, Verilog-AMS, VHDL, VHDL-AMS), and SystemC
 - Synchronization of time steps and convergence routines
- Questa's ability to simulate models from multiple hierarchy levels provides the capability to model a complex system
 - Accurate and detailed transistor level models (Temp Sensor)
 - IBIS models at digital interfaces for signal integrity
 - Behavioral level models for complex circuits (ADC, FPGA, etc.)
- We have successfully simulated behavioral models, IBIS models, Spice models and SystemC within one netlist and transient simulation

Temperature Regulation Loop – Questa ADMS



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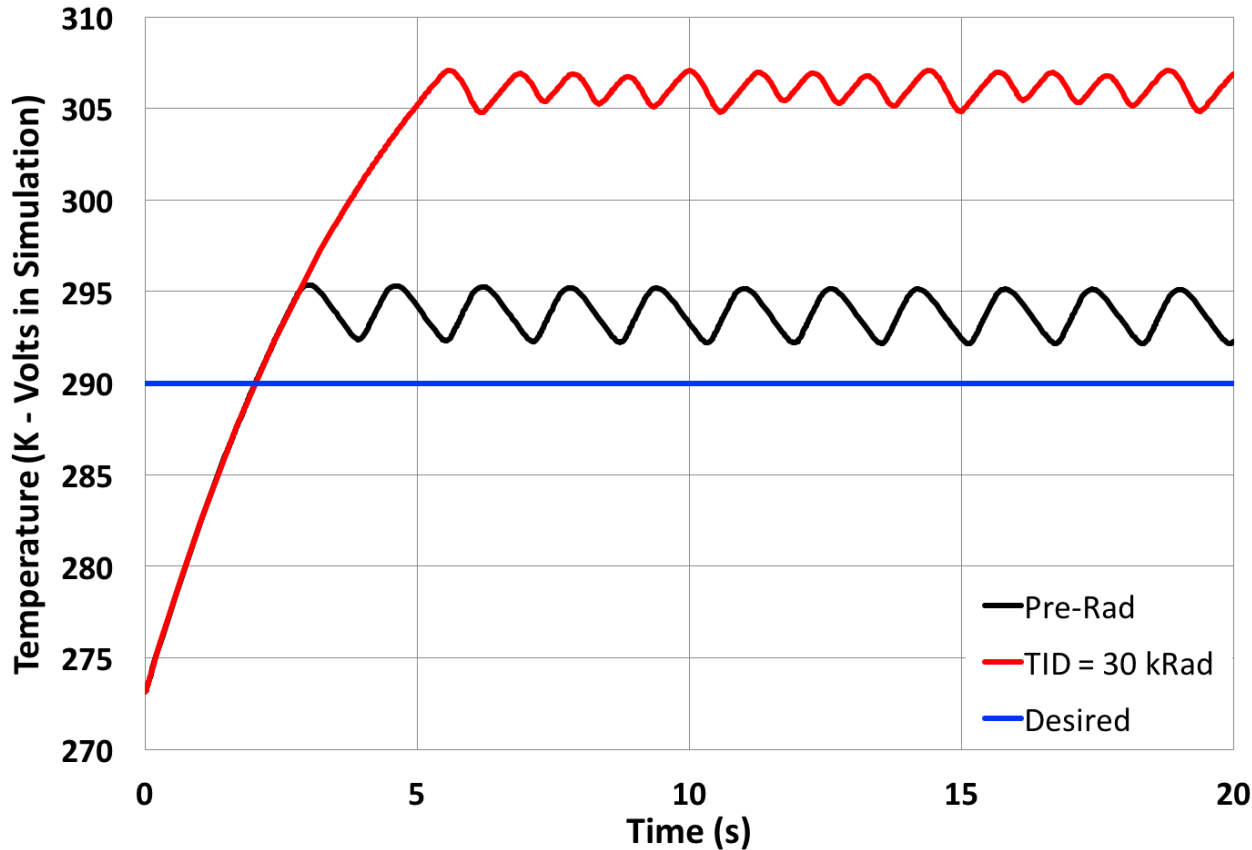


Questa ADMS Simulation Results - Temperature



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Regulated Temperature - Set Point = 290 K



Fast simulation
time ~20 sec

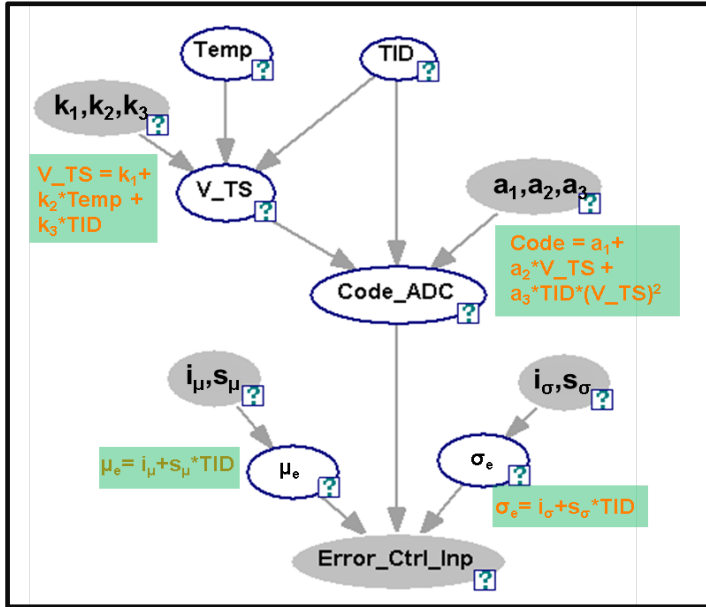
Set point = 290 K

Degraded models show
significant impact on
temperature profile



Continuous Bayesian Network (BN) Model

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BN Model (PyMC code)

- BN Nodes → Domain Variables and function parameters.
- Relationship between Nodes → Likelihood functions.

BN Setup/ Observations (Test bench data)

- Initialize parameter nodes with (prior) probability distributions.
- Associate evidence (data) with appropriate BN nodes.

BN Execution

- Markov Chain Monte Carlo sampling algorithms sample prior distributions and evaluate outputs (likelihood functions).
- Iterate until predictions converge to observed data.

BN Results

- Posterior (*updated*) distribution for each node.
- Use posterior distributions of parameters to get an estimation of the spread (distribution) in domain variables such as
 - *Output voltage of temperature sensor (V_TS)*
 - *Output code from ADC (Code_ADC)*
 - *Error in input to controller (Error_Ctrl_Input)*

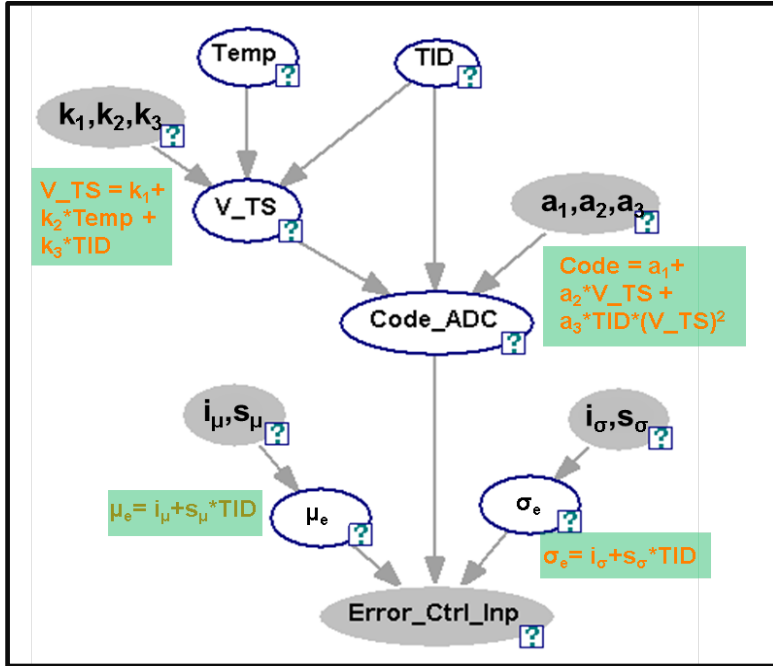
Legend

- X** -- Stochastic node – $X = \text{Gaussian}(\mu, \sigma)$
- y** -- Deterministic node ($V_TS, \text{Code}, \mu_e, \sigma_e$)
Root Nodes with Uniform priors (Temp, TID)
- Eqn.** -- Likelihood Function for deterministic nodes



Continuous Bayesian Network Results

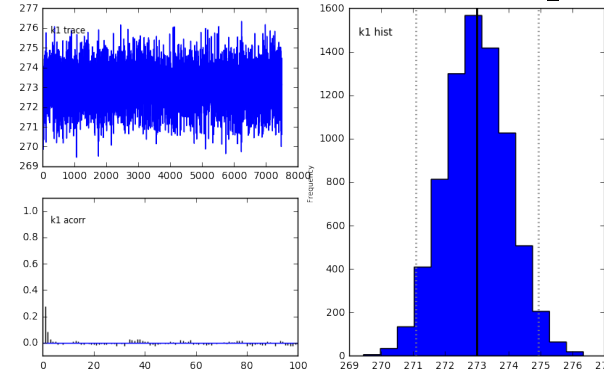
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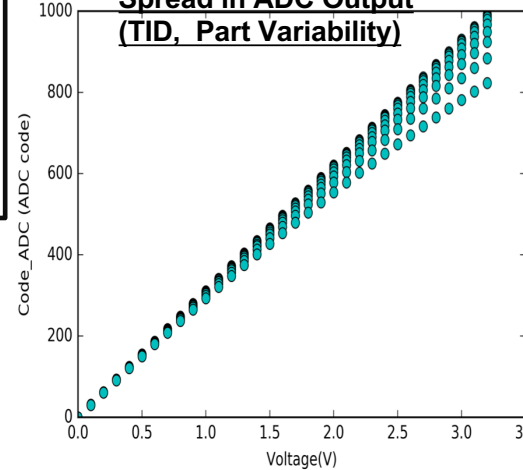
Legend

- X** -- Stochastic node – $X = \text{Gaussian}(\mu, \sigma)$
- y** -- Deterministic node (V_{TS} , Code, μ_e , σ_e)
Root Nodes with Uniform priors (Temp, TID)
- Eqn.** -- Likelihood Function for deterministic nodes

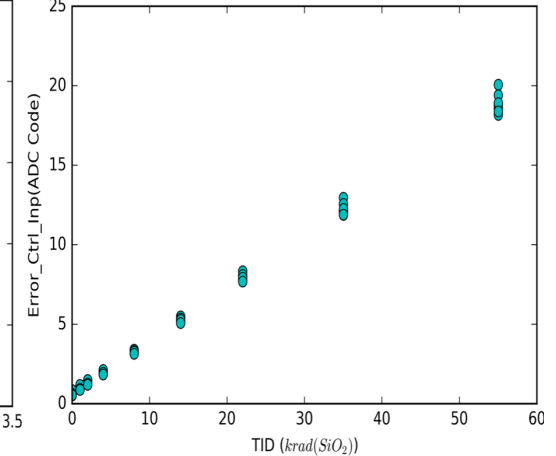
Posterior Distribution (parameter k_1)



Spread in ADC Output (TID, Part Variability)



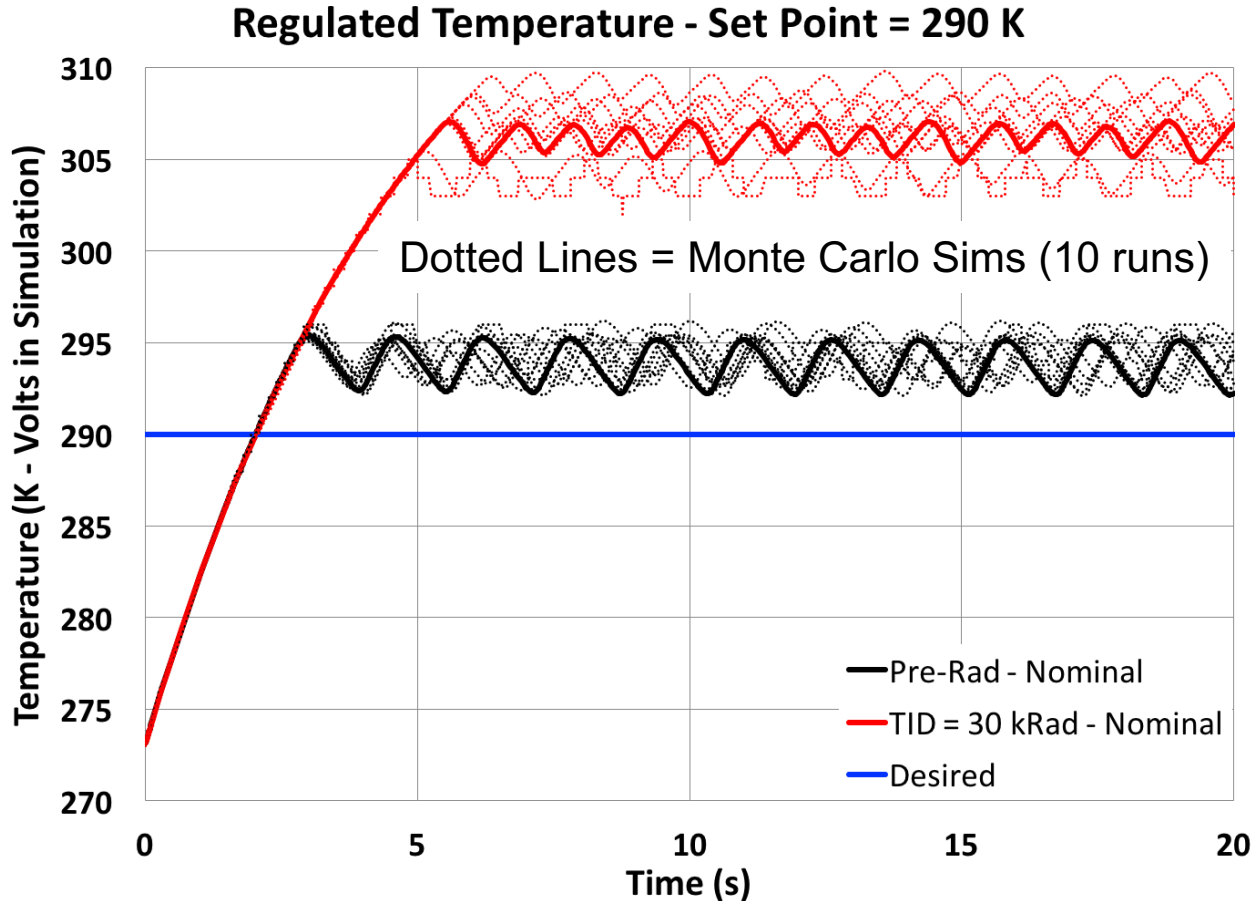
Controller Input Error with TID



Questa ADMS Sim Distributions Electrical and Radiation Parameters



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Set point = 290 K

Monte Carlo analysis of the circuit with Pre-Rad and 30 kRad component models

Black shows component variations pre-rad

Conclusions



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- Board-level modeling requires simulation of **analog, mixed-signal, and fully digital components**, as well as **software**
 - Created modeling and simulation paradigm for a fully capable, multi-domain board simulator using Mentor Questa with SystemC
 - Shows the impact of component-level variations on board-level system parameters
 - Fast run times for long simulation clock times
 - Fully customizable abstraction levels from software to all-digital to behavioral models to Spice-like circuit simulation
 - Compatible with other Mentor products like circuit board layout and parasitic tools
 - Parameter variation and Monte Carlo simulation capability
 - Simulation demonstrates significant impact on the system-level variable (Temperature) owing to TID degradation of ADC and sensor
 - Clear road map for next steps in C&DH radiation modeling
-